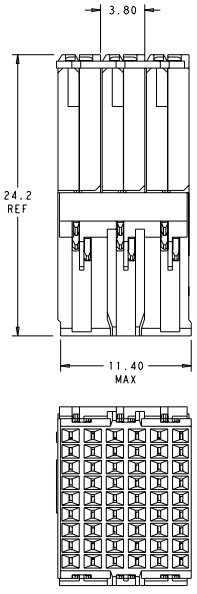
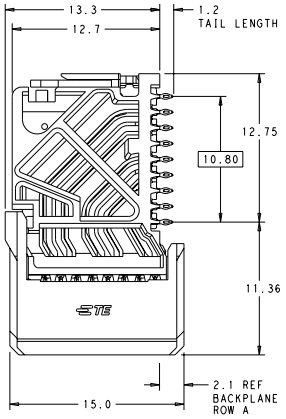
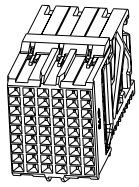
LOC	DIST
AD	00

REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
	C	REVISED PER ECO-12-000417	13JAN2012	KH	DD

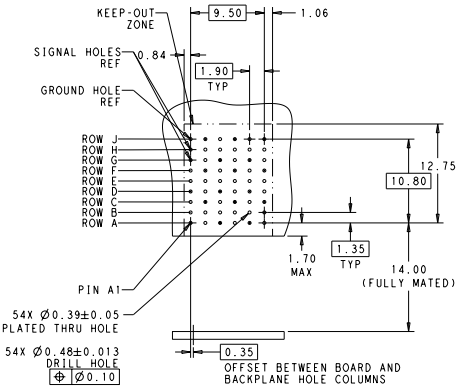
1. MATERIAL:
   HOUSING: LCP, GLASS FILLED, UL94V-0.
   TERMINALS: HIGH PERFORMANCE COPPER ALLOY.
2. FINISH:
   30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL.
3. FINISH:
   30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN-LEAD ON PCB TAILS, NICKEL OVERALL.







SCALE 4:1



RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.0

NONE	3	2132500-5
NONE	2	2132500-1
KEY POSITION	FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: MM

TOLERANCES UNLESS OTHERWISE SPECIFIED:
3 PLC ±
2 PLC ±0.2
1 PLC ±0.10
X PLC ±
ANGLES ±

MATERIAL 1

FINISH SEE TABLE

DRN	M. MILLER	23SEP2010
CH	D. DIXON	23SEP2010
APVD	D. DIXON	23SEP2010
PRODUCT SPEC	-	
APPLICATION SPEC	-	
WEIGHT	-	

TE Connectivity

NAME: IMPACT, 3 PAIR, DAUGHTERCARD 6 COLUMN, UNGUIDED, SIGNAL MODULE, 0.39 EYELET

SIZE	CAGE CODE	DRAWING NO	RESTRICTED TO
A1	00779	C-2132500	-

CUSTOMER DRAWING

SCALE 6:1 SHEET 1 OF 1 REV C

4005 12JAN12

Pro/ENGINEER DRAWING

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